

### Product Change Notification / ASER-18NDSR054

## Date:

17-Mar-2021

## **Product Category:**

Interface- Controller Area Network (CAN), Interface- LIN Transceiver

# PCN Type:

Manufacturing Change

## **Notification Subject:**

CCB 4086 and 4086.001 Final Notice: Qualification of MMT as an additional assembly site for ATA663xx, ATA656xx, ATA662xx and ATA657xx device families available in 8L VDFN (3.0x3.0x1.0mm) and 14L VDFN (3.0x4.5x0.9 mm) packages.

## Affected CPNs:

ASER-18NDSR054\_Affected\_CPN\_03172021.pdf ASER-18NDSR054\_Affected\_CPN\_03172021.csv

# Notification Text:

PCN Status: Final notification

PCN Type: Manufacturing Change

Microchip Parts Affected: Please open one of the files found in the Affected CPNs section.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

**Description of Change:** Qualification of MMT as an additional assembly site for ATA663xx, ATA656xx, ATA662xx and ATA657xx device families available in 8L VDFN (3.0x3.0x1.0mm) and 14L VDFN (3.0x4.5x0.9 mm) packages.

**Pre Change:** Assembled at ASCL using EN-4900 die attach, C7025 (8L VDFN) **or** C194 (14L VDFN) lead frame material without lead lock.

Post Change: Assembled at ASCL using EN-4900 die attach, C7025 (8L VDFN) or C194 (14L VDFN) lead frame material without lead lock.or

Assembled at MMT using 3280 die attach, C194 (8L and 14L VDFN) lead frame material with lead lock.

Pre and Post Change Summary:

	Pre Change	Post Change						
Assembly Site	ASE Group Chung-Li (ASCL)	ASE Group Chung-Li (ASCL)	Microchip Technology Thailand Branch (MMT)					
Wire Material	CuPdAu	CuPdAu	CuPdAu					
Die Attach Material	EN-4900	EN-4900	3280					
Molding Compound Material	G700	G700	G700					
Lead Frame Material	For 8L VDFN: C7025 For 14L VDFN: C194	For 8L VDFN: C7025 For 14L VDFN: C194	C194					
Lead Lock (Locking Hole)	No	No	Yes					

Impacts to Data Sheet: Yes, refer to POD comparison table.

Dimensions in mm

			ASCL		ММТ				
Dimension	Symbol	Min	Nom	max	Min	Nom	Max		
Overall height	А	0.80	0.85	0.90	0.80	0.90	1.00		
Wettable flank step length	D3	-	-	0.040	-	-	0.085		
Wettable flank step height	A4	0.10	-	0.15	0.10	-	0.19		

Change Impact:

None

Reason for Change: To improve manufacturability by adding MMT as an additional assembly site.

Change Implementation Status: In Progress

Estimated First Ship Date: April 30, 2021 (date code: 2118)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

### Time Table Summary:

	January 2020			>	March 2021				April 2021						
Workweek	01	02	03	04	05		10	11	12	13	14	15	16	17	18
Initial PCN Issue Date				Х											
Qual Report Availability									Х						
Final PCN Issue Date									Х						
Estimated Implementation Date															Х

Method to Identify Change: Traceability code

**Qualification Report:** Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

### Revision History: January 24, 2020: Issued initial notification.

March 17, 2021: Issued final notification. Attached the qualification report and added estimated first ship date by April 30, 2021.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

## Attachments:

PCN\_ASER-18NDSR054\_Qual\_Report.pdf PCN\_ASER-18NDSR054\_Pre and Post Change\_Summary.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

### **Terms and Conditions:**

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections. ASER-18NDSR054 - CCB 4086 and 4086.001 Final Notice: Qualification of MMT as an additional assembly site for ATA663xx, ATA656xx, ATA662xx and ATA657xx device families available in 8L VDFN (3.0x3.0x1.0mm) and 14L VDFN (3.0x4.5x0.9 mm) packages.

Affected Catalog Part Numbers (CPN)

ATA663254-GBQW ATA663211-GBQW ATA663255-GBQW ATA663232-GBQW ATA663231-GBQW ATA663201-GBQW ATA663203-GBQW ATA6562-GBQW0 ATA6566-GBQW0 ATA6563-GBQW0 ATA6564-GBQW0 ATA6565-GCQW0 ATA6562-GBQW1 ATA6561-GBQW ATA6560-GBQW ATA6564-GBQW1 ATA6563-GBQW1 ATA6566-GBQW1 ATA6560-GBQW-N ATA6561-GBQW-N ATA6565-GCQW1 ATA6625-GBQW ATA6570-GCQW0 ATA6570-GCQW1 ATA6571-GCQW0-VAO ATA6571-GCQW1-VAO ATA663254-GBQW-VAO ATA663231-GBQW-VAO ATA6560-GBQW-VAO